μ PA2464T1Q MOS FIELD EFFECT TRANSISTOR

Description

The μ PA2464T1Q is a switching device, which can be driven directly by a 2.5 V power source.

The μ PA2464T1Q features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

Features

- 2.5 V drive available
- Low on-state resistance
 - --- $R_{DS(on)1} = 26.0 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.5 \text{ V}, I_D = 3.0 \text{ A})$
 - --- $R_{DS(on)2} = 27.0 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.0 \text{ V}, I_D = 3.0 \text{ A})$
 - --- $R_{DS(on)3} = 30.0 \text{ m}\Omega \text{ MAX}. (V_{GS} = 3.1 \text{ V}, I_D = 3.0 \text{ A})$
 - --- $R_{DS(on)4} = 38.0 \text{ m}\Omega \text{ MAX}. (V_{GS} = 2.5 \text{ V}, I_D = 3.0 \text{ A})$
- Built-in G-S protection diode against ESD

Ordering Information

Part No.	LEAD PLATING	PACKING	Package
μ PA2464T1Q-E1-AX ^{*1}	Ni/Pd/Au	8 mm embossed taping	8-pin HUSON (2720)
		3000 p/reel	

Note: *1. Pb-free (This product does not contain Pb in the external electrode and other parts.)

Absolute Maximum Ratings (T_A = 25°C)

Item	Symbol	N-CHANNEL	Unit
Drain to Source Voltage (V_{GS} = 0 V)	V _{DSS}	30	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±12	V
Drain Current (DC) *1	I _{D(DC)}	±6	А
Drain Current (pulse) *2	I _{D(pulse)}	±45	А
Total Power Dissipation (2 unit) *1	P _{T1}	1.0	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature	T _{stg}	–55 to +150	°C

Notes: *1. Mounted on a glass epoxy board of 25.4 mm x 25.4 mm x 0.8 mmt *2. PW \leq 10 μ s, Duty Cycle \leq 1%



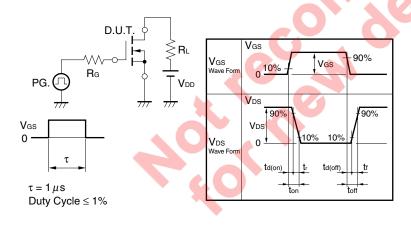
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Electrical Characteristics (T_A = 25°C)

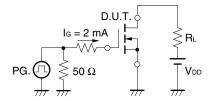
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}			1	μA	V_{DS} = 30 V, V_{GS} = 0 V
Gate Leakage Current	I _{GSS}			±10	μA	V_{GS} = ±12 V, V_{DS} = 0 V
Gate to Source Cut-off Voltage	V _{GS(off)}	0.5	1	1.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance *1	y _{fs}	2.5			S	V _{DS} = 10 V, I _D = 3.0 A
Drain to Source On-state	R _{DS(on)1}	15	20	26	mΩ	V_{GS} = 4.5 V, I _D = 3.0 A
Resistance ^{*1}	R _{DS(on)2}	16	20.5	27	mΩ	V_{GS} = 4.0 V, I_{D} = 3.0 A
	R _{DS(on)3}	17	22	30	mΩ	V_{GS} = 3.1 V, I_{D} = 3.0 A
	R _{DS(on)4}	19	26	38	mΩ	V_{GS} = 2.5 V, I_D = 3.0 A
Input Capacitance	C _{iss}		700		pF	V _{DS} = 10 V,
Output Capacitance	C _{oss}		77		pF	V _{GS} = 0 V,
Reverse Transfer Capacitance	C _{rss}		48		pF	f = 1 MHz
Turn-on Delay Time	t _{d(on)}		3		μs	V _{DD} = 15 V, I _D = 3.0 A,
Rise Time	tr		5		μs	V _{GS} = 4 V,
Turn-off Delay Time	t _{d(off)}		14		μs	R _G = 6 Ω
Fall Time	t _f		9		μs	
Total Gate Charge	Q _G		7		nC	V _{DD} = 24 V,
Gate to Source Charge	Q _{GS}		1.3		nC	V _{GS} = 4 V,
Gate to Drain Charge	Q _{GD}		2.5		nC	I _D = 6.0 A
Body Diode Forward Voltage *1	V _{F(S-D)}		0.83		V	I _F = 6.0 A, V _{GS} = 0 V

Note: *1. Pulsed

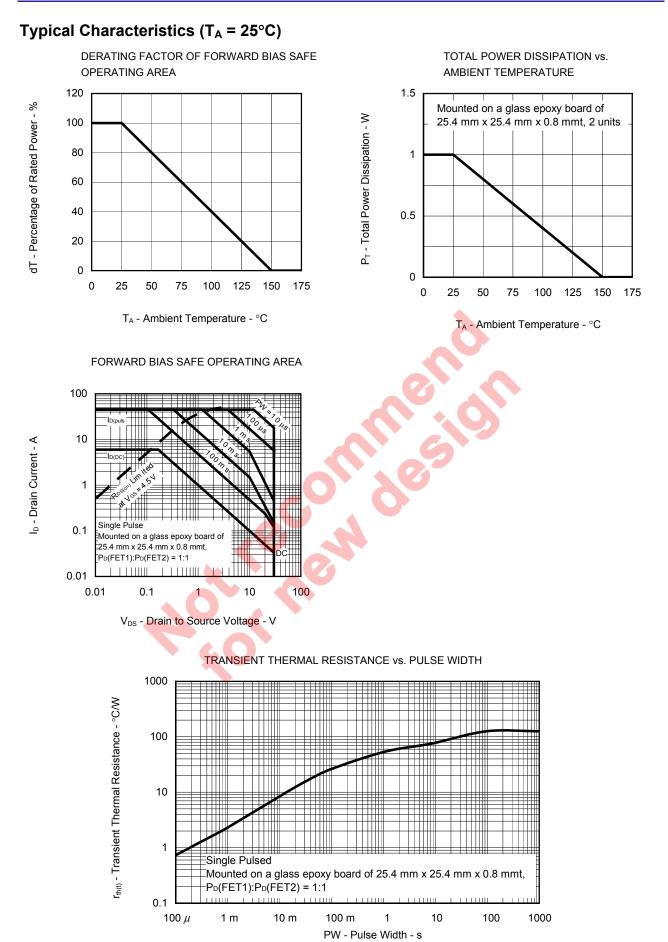
TEST CIRCUIT 1 SWITCHING TIME



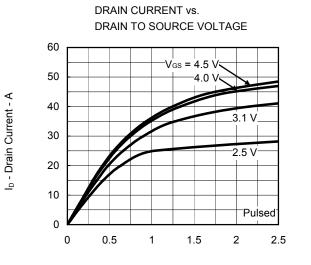
TEST CIRCUIT 2 GATE CHARGE



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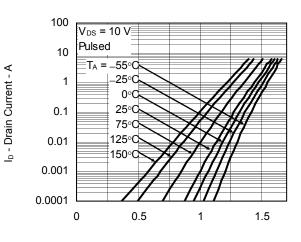


V_{DS} - Drain to Source Voltage - V

GATE TO SOURCE CUT-OFF VOLTAGE vs.

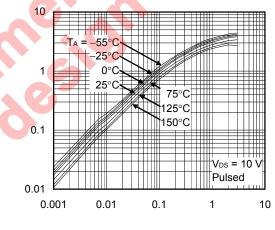
CHANNEL TEMPERATURE

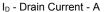
FORWARD TRANSFER CHARACTERISTICS



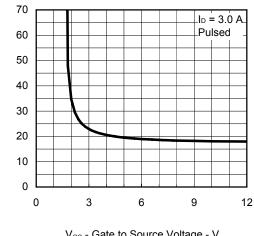
V_{GS} - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT





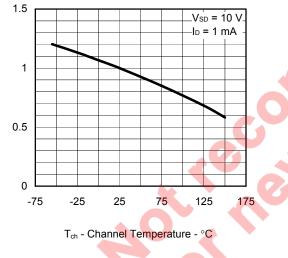




V_{GS} - Gate to Source Voltage - V



V_{GS(off)} - Gate to Source Cut-off Voltage - V



DRAIN CURRENT $R_{\text{DS(on)}}$ - Drain to Source On-state Resistance - $m\Omega$ 50 45 Vgs = 4.5 40 35 30 25 20 ++15 10 5 0 0.1 1 I_D - Drain Current - A

DRAIN TO SOURCE ON-STATE RESISTANCE vs.

4.0

3.1

2.5

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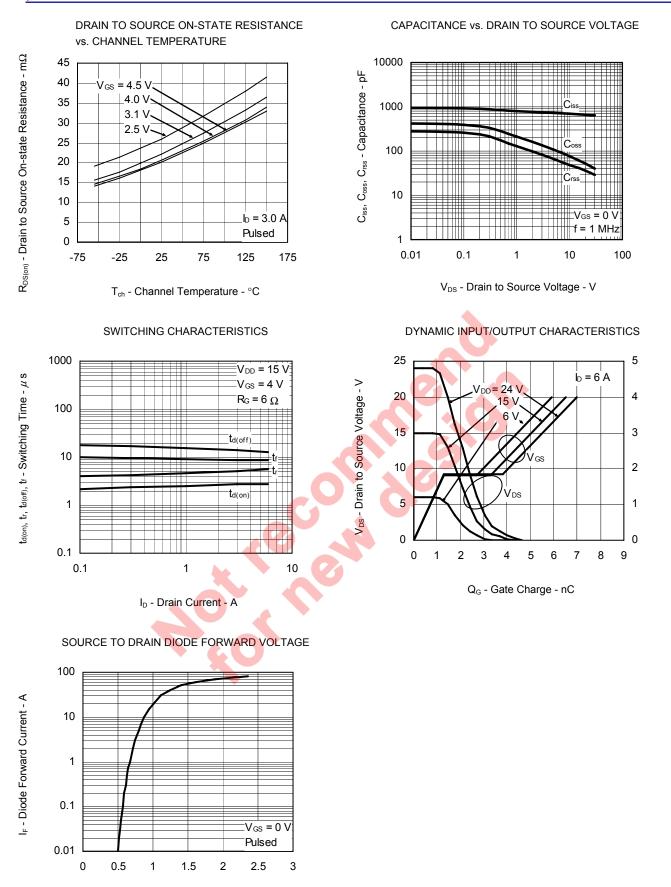
 $R_{\text{DS(on)}}$ - Drain to Source On-state Resistance - $m\Omega$

Pulsed

100

10

y_{fs}] - Forward Transfer Admittance - S



 $V_{\text{F(S-D)}}$ - Source to Drain Voltage - V

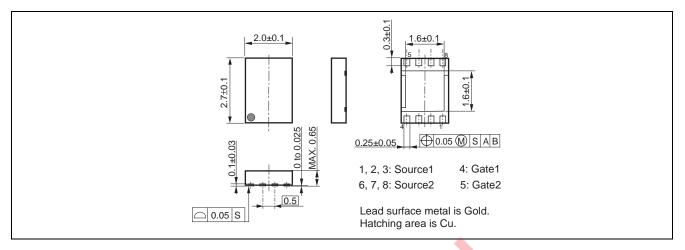
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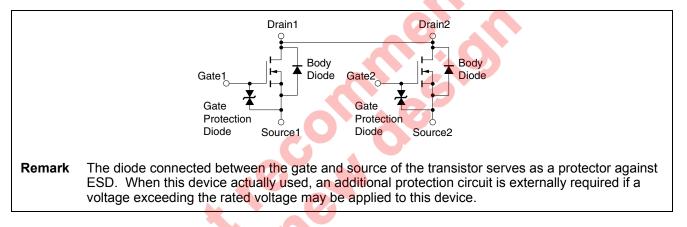
V_{GS} - Gate to Source Voltage - V

Package Drawings (Unit: mm)

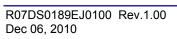
8-pin HUSON (2720)



Equivalent Circuit



2.0





<Notes for using this device safely>

When you use this device, in order to prevent a customer's hazard and damage, use it with understanding the following contents. If used exceeding recommended conditions, there is a possibility of causing failure of the device and characteristic degradation.

- 1. When you mount the device on a substrate, carry out within our recommended soldering conditions of infrared reflow. If mounted exceeding the conditions, the characteristic of a device may be degraded and it may result in failure.
- 2. When you wash the device mounted the substrate, carry out within our recommended conditions. If washed exceeding the conditions, the characteristic of a device may be degraded and it may result in failure.
- 3. When you use ultrasonic wave to substrate after the device mounting, prevent from touching a resonance generator directly. If it touches, the characteristic of a device may be degraded and it may result in failure.
- 4. Please refer to Figure 1 as an example of the land pattern. Optimize the land pattern in consideration of density, appearance of solder fillets, common difference, etc in an actual design.

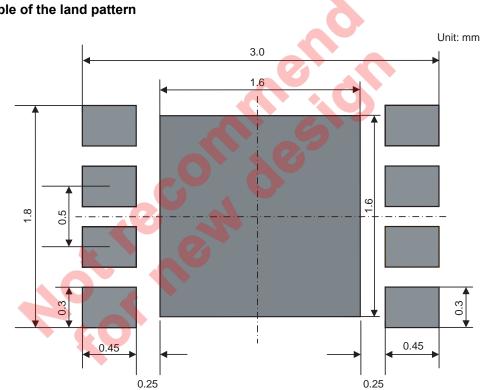


Figure 1. Example of the land pattern



Revision	History
1164131011	THEFT

μPA2464T1Q Data Sheet

		Description		
Rev.	Date	Page	Summary	
1.00	Dec 06, 2010	-	First Edition Issued	



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